



Power MOSFETS

DATASHEET

LM60346NAL3A

N-Channel
Enhancement Mode MOSFET

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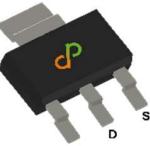
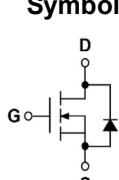
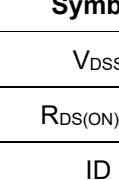
Quality Management Systems
ISO 9001:2015 Certificate

LM60346NAL3A

N-Channel Enhancement Mode MOSFET

Pin Description

Product Summary

SOT-223 (TOP view)	Symbol	Symbol	N-Channel	Unit	
			V _{DSS}	60	V
			R _{DS(ON)-Max}	38	mΩ
			I _D	6.8	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free

Applications

- Motor Control
- Power Tools
- Load Switching

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM60346NAL3A	SOT-223	Tape & Reel	2500 / Tape & Reel	02□□□

Note : □□□= Lot Code

Absolute Maximum Ratings (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V _{DSS}	Drain-Source Voltage	60	V
V _{GSS}	Gate-Source Voltage	±20	
T _J	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
I _{DM} ^①	Pulse Drain Current Tested	T _A =25°C 17	A
I _D	Continuous Drain Current	T _A =25°C T _A =70°C 6.8 5.5	A
P _D	Maximum Power Dissipation	T _A =25°C T _A =70°C 1.8 1.1	W
I _{AS} ^②	Avalanche Current, Single pulse	L=0.1mH L=0.5mH 19 10	A
E _{AS} ^②	Avalanche Energy, Single pulse	L=0.1mH L=0.5mH 18 26	mJ

Thermal Characteristics

Symbol	Parameter	Rating	Unit
R _{θJA} ^③	Thermal Resistance-Junction to Ambient	t ≤ 10s 35	°C/W
		Steady State 70	°C/W

Note ① : Max. current is limited by junction temperature.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

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N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{DS}}=250\mu\text{A}$	60	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=48\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{DS}}=250\mu\text{A}$	1.3	1.8	2.5	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\circledast}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{DS}}=20\text{A}$	-	32	38	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$, $I_{\text{DS}}=10\text{A}$	-	35	45	
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{DS}}=20\text{A}$	-	16	-	S
Dynamic Characteristics [®]						
R_{G}	Gate Resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, Freq.=1MHz	-	3.9	-	Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=30\text{V}$, Freq.=1MHz	-	1150	-	pF
C_{oss}	Output Capacitance		-	52	-	
C_{rss}	Reverse Transfer Capacitance		-	40	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=30\text{V}$, $I_{\text{D}}=1\text{A}$, $R_{\text{GEN}}=6\Omega$	-	6.9	-	nS
t_{r}	Turn-on Rise Time		-	3.5	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	32.7	-	
t_{f}	Turn-off Fall Time		-	18.1	-	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=4.5\text{V}$, $V_{\text{DS}}=30\text{V}$ $I_{\text{D}}=6\text{A}$	-	12	-	nC
Q_{g}	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=30\text{V}$, $I_{\text{D}}=6\text{A}$	-	26	-	
Q_{gs}	Gate-Source Charge		-	6.4	-	
Q_{gd}	Gate-Drain Charge		-	3.7	-	
Source-Drain Characteristics						
$V_{\text{SD}}^{\circledast}$	Diode Forward Voltage	$I_{\text{SD}}=20\text{A}$, $V_{\text{GS}}=0\text{V}$	-	0.9	1.1	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=3\text{A}$, $V_{\text{R}}=30\text{V}$	-	14	-	nS
Q_{rr}	Reverse Recovery Charge	$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	9	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

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N-Channel Typical Characteristics

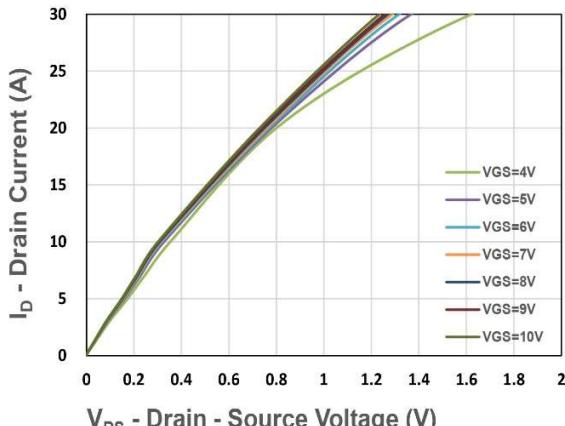


Figure 1. Output Characteristics

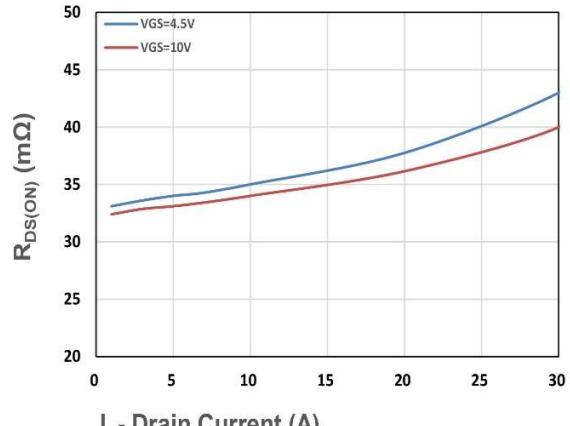


Figure 2. On-Resistance vs. ID

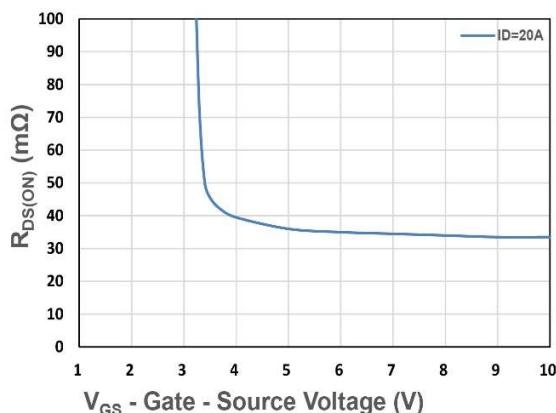


Figure 3. On-Resistance vs. VGS

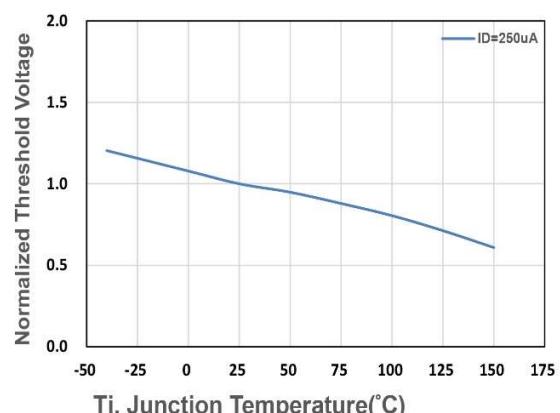


Figure 4. Gate Threshold Voltage

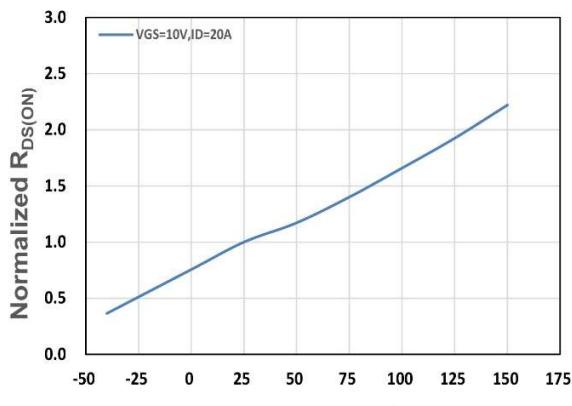


Figure 5. Drain-Source On Resistance

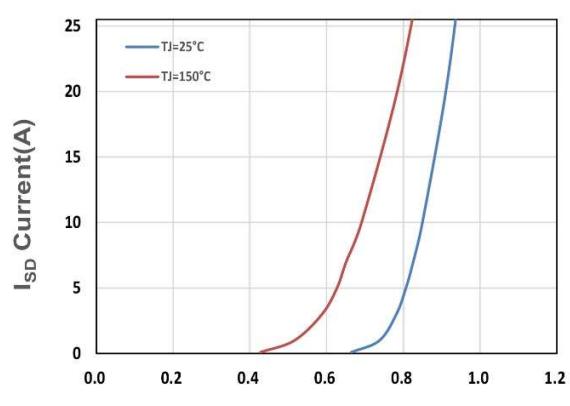
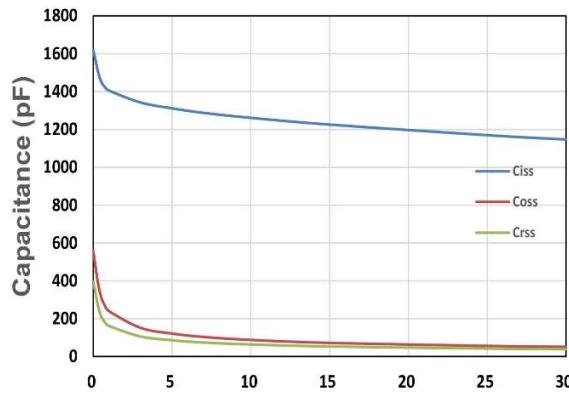
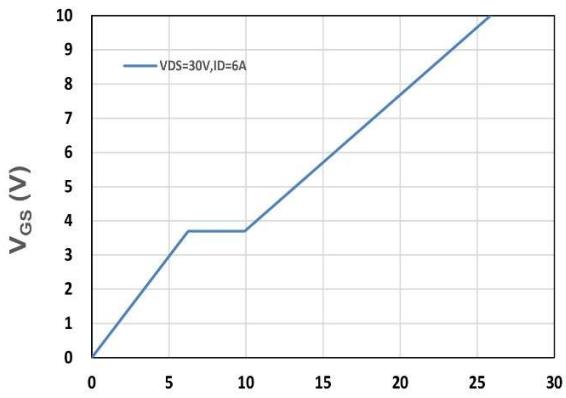


Figure 6. Source-Drain Diode Forward

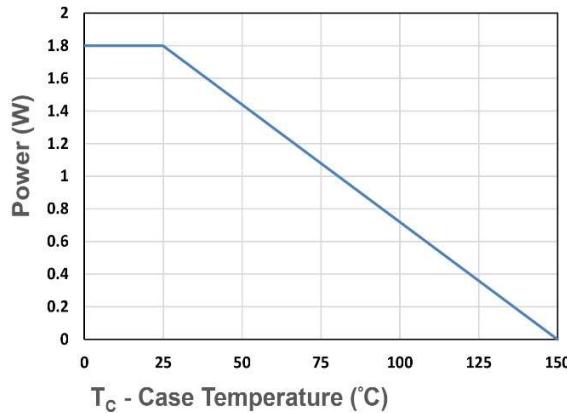
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V_{DS} - Drain - Source Voltage (V)
Figure 7. Capacitance

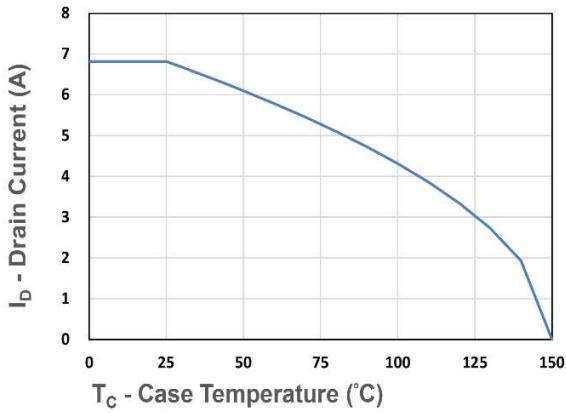


Q_g , Total Gate Charge (nC)
Figure 8. Gate Charge Characteristics



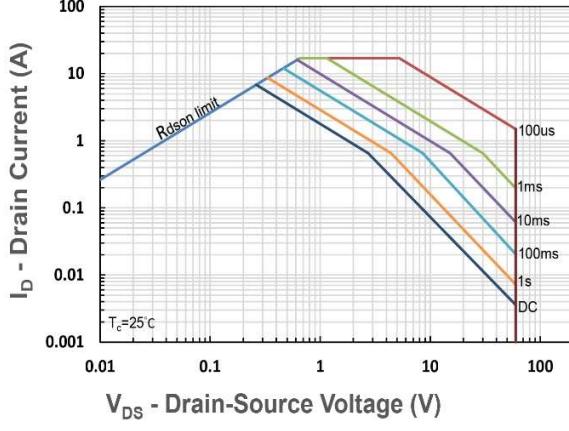
T_c - Case Temperature (°C)

Figure 9. Power Dissipation



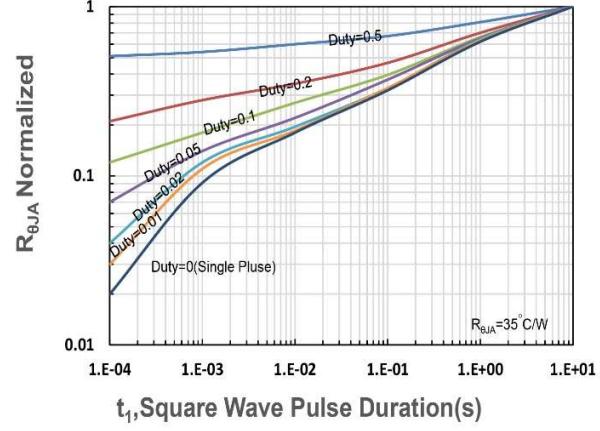
T_c - Case Temperature (°C)

Figure 10. Drain Current



V_{DS} - Drain-Source Voltage (V)

Figure 11. Safe Operating Area



t_1 , Square Wave Pulse Duration(s)

Figure 12. R_{eJA} Transient Thermal Impedance